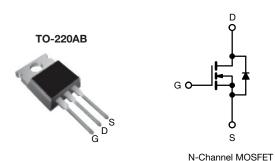
COMPLIANT

HALOGEN

**FREE** 



# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
$R_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C	$V_{GS} = 10 \text{ V}$	0.061			
Q <sub>g</sub> max. (nC)	189				
Q <sub>gs</sub> (nC)	26				

55

Single

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP38N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600	V	
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{C} = 25  ^{\circ}C$ $T_{C} = 100  ^{\circ}C$	- I <sub>D</sub>	40	А	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		25		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	111		
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	508	mJ	
Maximum power dissipation			$P_{D}$	313	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$T_{J} = T_{J}$	T <sub>J</sub> = 125 °C		100	V/ns	
Reverse diode dv/dt <sup>d</sup>			dv/dt	50	V/IIS	
Soldering recommendations (peak temperature)	) <sup>c</sup> For	For 10 s		260	°C	

#### Notes

Q<sub>gd</sub> (nC)

Configuration

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 6.0 A
- c. 1.6 mm from case
- d.  $I_{SD}$  = 23.5 A, di/dt = 250 A/ $\mu$ s, starting  $T_J$  = 25 °C

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	40	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.4	G/ VV	



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 10 mA		-	0.72	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2	-	4	V
Cata aguirea laglaga		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	$I_{GSS}$	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
Zoro goto voltago droin ourrent	1	V <sub>DS</sub> =	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V		-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2	mA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 23.5 A	-	0.061	0.070	Ω
Forward transconductance a	9fs	V <sub>DS</sub> =	30 V, I <sub>D</sub> = 23.5 A	-	13	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	3576	-	pF
Output capacitance	C <sub>oss</sub>	,	$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		167	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	104	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	535	-	
Total gate charge	Qg			-	126	189	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 23.5 A, V <sub>DS</sub> = 480 V		-	26	-	nC
Gate-drain charge	Q <sub>gd</sub>				55	-	
Turn-on delay time	t <sub>d(on)</sub>			-	35	70	
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, I_{D} = 23.5 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	63	126	ns
Turn-off delay time	t <sub>d(off)</sub>			-	143	286	
Fall time	t <sub>f</sub>			-	67	134	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I <sub>SM</sub>			-	-	111	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 23.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 23.5 A, di/dt = 100 A/μs, V <sub>R</sub> = 400 V		-	160	320	ns
Reverse recovery charge	Q <sub>rr</sub>			-	1.2	2.4	μC
Reverse recovery current	I <sub>RRM</sub>			-	14.3	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

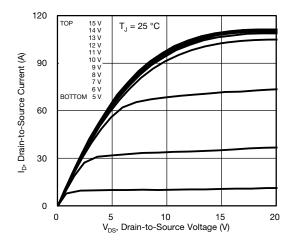


Fig. 1 - Typical Output Characteristics

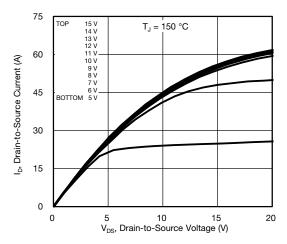


Fig. 2 - Typical Output Characteristics

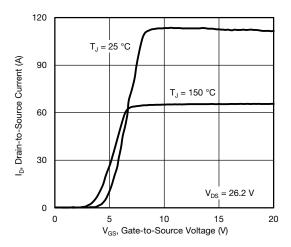


Fig. 3 - Typical Transfer Characteristics

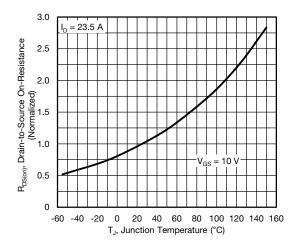


Fig. 4 - Normalized On-Resistance vs. Temperature

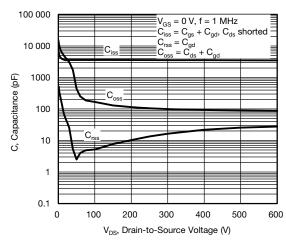


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

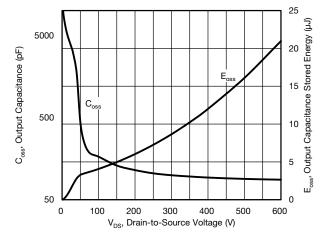


Fig. 6 - Coss and Eoss vs. VDS



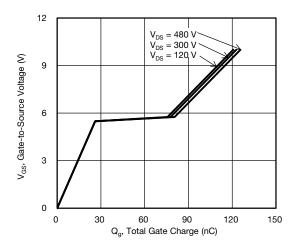


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

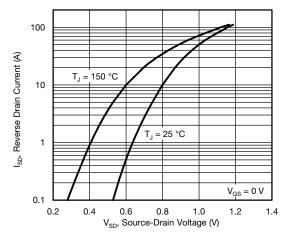


Fig. 8 - Typical Source-Drain Diode Forward Voltage

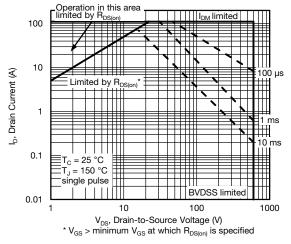


Fig. 9 - Maximum Safe Operating Area

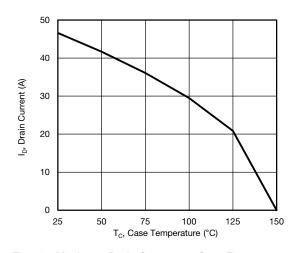


Fig. 10 - Maximum Drain Current vs. Case Temperature

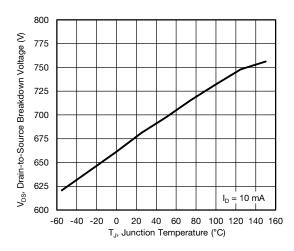


Fig. 11 - Temperature vs. Drain-to-Source Voltage



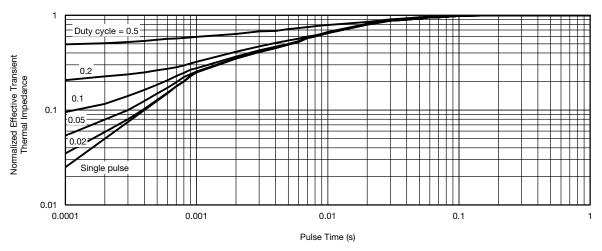


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

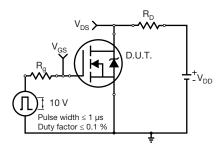


Fig. 13 - Switching Time Test Circuit

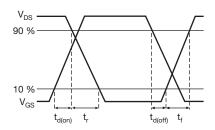


Fig. 14 - Switching Time Waveforms

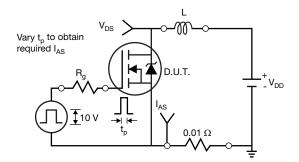


Fig. 15 - Unclamped Inductive Test Circuit

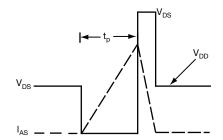


Fig. 16 - Unclamped Inductive Waveforms

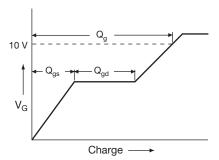


Fig. 17 - Basic Gate Charge Waveform

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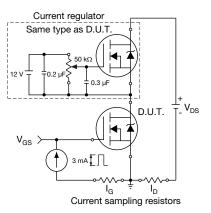


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dv/dt Test Circuit

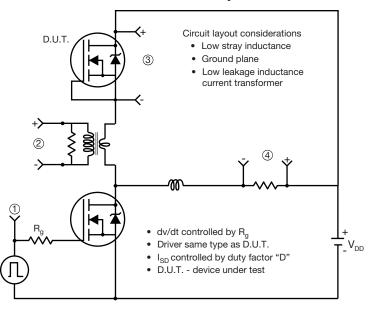




Fig. 19 - For N-Channel

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